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June 2014

## FDP86363\_F085

# N-Channel PowerTrench<sup>®</sup> MOSFET 80 V, 110 A, 2.8 m $\Omega$

#### **Features**

- Typical  $R_{DS(on)}$  = 2.4 m $\Omega$  at  $V_{GS}$  = 10V,  $I_D$  = 80 A
- Typical  $Q_{q(tot)}$  = 131 nC at  $V_{GS}$  = 10V,  $I_D$  = 80 A
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

#### **Applications**

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Integrated Starter/Alternator
- Primary Switch for 12V Systems



For current package drawing, please refer to the Fairchild website at www.fairchildsemi.com/packaging

TO-220

#### **MOSFET Maximum Ratings** T<sub>J</sub> = 25°C unless otherwise noted.

Symbol	Parameter		Ratings	Units	
$V_{DSS}$	Drain-to-Source Voltage		80	V	
$V_{GS}$	Gate-to-Source Voltage		±20	V	
	Drain Current - Continuous ( $V_{GS}$ =10) (Note 1) $T_C$ = 25°C		110	۸	
ID	Pulsed Drain Current $T_C = 25^{\circ}C$		See Figure 4	Α	
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 2)	512	mJ	
D	Power Dissipation		300	W	
$P_{D}$	Derate Above 25°C		2.0	W/°C	
$T_J$ , $T_{STG}$	Operating and Storage Temperature		-55 to + 175	°C	
$R_{\theta JC}$	Thermal Resistance, Junction to Case		0.5	°C/W	
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient	(Note 3)	43	°C/W	

#### Notes

- 1: Current is limited by bondwire configuration.
- 2: Starting  $T_J = 25$  °C, L = 0.25mH,  $I_{AS} = 64$ A,  $V_{DD} = 80$ V during inductor charging and  $V_{DD} = 0$ V during time in avalanche.
- 3: R<sub>0,JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>0,JC</sub> is guaranteed by design, while R<sub>0,JA</sub> is determined by the board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.

#### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDP86363	FDP86363_F085	TO220AB	Tube	N/A	50 units

Units

Max.

## **Electrical Characteristics** $T_J = 25$ °C unless otherwise noted.

**Parameter** 

Off Characteristics						
B <sub>VDSS</sub>	Drain-to-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	80	-	-	V
1	I <sub>DSS</sub> Drain-to-Source Leakage Current	$V_{DS}$ =80V, $T_J$ = 25°C	-	-	1	μΑ
DSS		$V_{GS} = 0V$ $T_J = 175^{\circ}C$ (Note 4	-	-	1	mA
$I_{GSS}$	Gate-to-Source Leakage Current	$V_{GS} = \pm 20V$	-	-	±100	nA

**Test Conditions** 

Min.

Тур.

#### **On Characteristics**

Symbol

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$		2.0	3.0	4.0	V
R <sub>DS(on)</sub> Drain to Source On Resistance	I <sub>D</sub> = 80A,	$T_{\rm J} = 25^{\rm o}{\rm C}$	-	2.4	2.8	mΩ	
	V <sub>GS</sub> = 10V	$T_J = 175^{\circ}C \text{ (Note 4)}$	-	3.8	4.3	mΩ	

#### **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	\/ - 40\/ \/ -	0) /	-	10000	-	pF
C <sub>oss</sub>	Output Capacitance	→ v <sub>DS</sub> = 40v, v <sub>GS</sub> = 1 — f = 1MHz	$V_{DS} = 40V, V_{GS} = 0V,$		1400	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 1101112		-	95	-	pF
$R_g$	Gate Resistance	f = 1MHz		-	3.3	-	Ω
$Q_{g(ToT)}$	Total Gate Charge at 10V	$V_{GS} = 0$ to 10V	V <sub>DD</sub> = 64V	-	131	150	nC
Q <sub>g(th)</sub>	Threshold Gate Charge	$V_{GS} = 0 \text{ to } 2V$	I <sub>D</sub> = 80A	-	18	21	nC
$Q_{gs}$	Gate-to-Source Gate Charge			-	47	-	nC
Q <sub>gd</sub>	Gate-to-Drain "Miller" Charge			-	24	-	nC

#### **Switching Characteristics**

t <sub>on</sub>	Turn-On Time	$V_{DD} = 40V, I_{D} = 80A,$ $V_{GS} = 10V, R_{GEN} = 6\Omega$	-	-	231	ns
$t_{d(on)}$	Turn-On Delay		-	38	1	ns
t <sub>r</sub>	Rise Time		-	129	-	ns
t <sub>d(off)</sub>	Turn-Off Delay		-	64	-	ns
t <sub>f</sub>	Fall Time		-	40	-	ns
t <sub>off</sub>	Turn-Off Time		-	-	135	ns

#### **Drain-Source Diode Characteristics**

V	Source-to-Drain Diode Voltage	I <sub>SD</sub> =80A, V <sub>GS</sub> = 0V	-	-	1.25	V
$V_{SD}$	Source-to-Drain blode voltage	$I_{SD} = 40A, V_{GS} = 0V$	-	-	1.2	٧
t <sub>rr</sub>	Reverse-Recovery Time	$I_F = 80A$ , $dI_{SD}/dt = 100A/\mu s$ ,	-	88	101	ns
Q <sub>rr</sub>	Reverse-Recovery Charge	V <sub>DD</sub> =64V	-	129	157	nC

#### Note:

4: The maximum value is specified by design at  $T_J$  = 175°C. Product is not tested to this condition in production.

V<sub>GS</sub> = 10V

175

**CURRENT LIMITED** BY SILICON

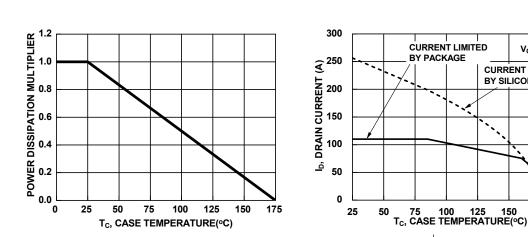
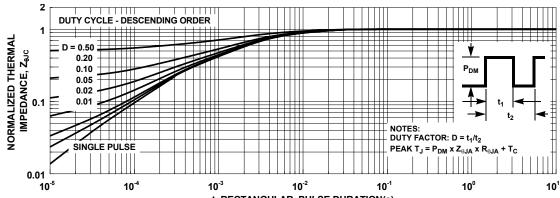


Figure 1. Normalized Power Dissipation vs. Case **Temperature** 

**Typical Characteristics** 

Figure 2. Maximum Continuous Drain Current vs. **Case Temperature** 



t, RECTANGULAR PULSE DURATION(s)
Figure 3. Normalized Maximum Transient Thermal Impedance

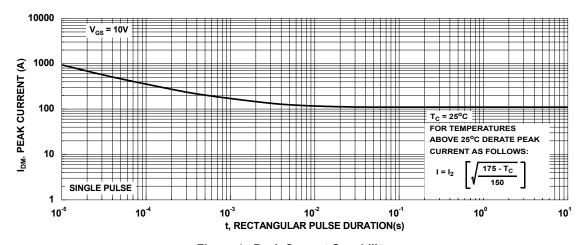


Figure 4. Peak Current Capability

### **Typical Characteristics**

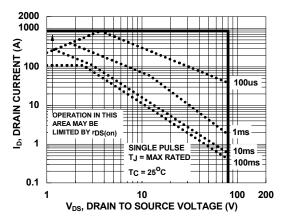
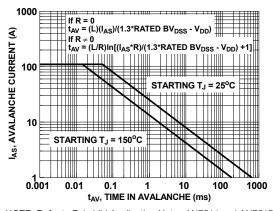


Figure 5. Forward Bias Safe Operating Area



NOTE: Refer to Fairchild Application Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching

Capability

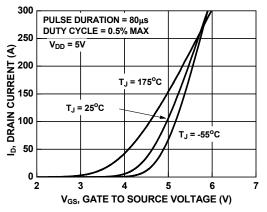


Figure 7. Transfer Characteristics

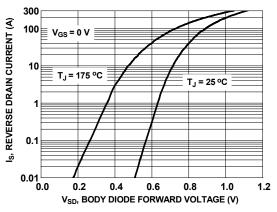


Figure 8. Forward Diode Characteristics

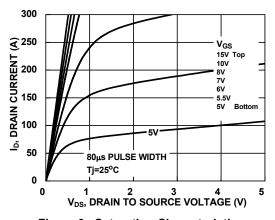


Figure 9. Saturation Characteristics

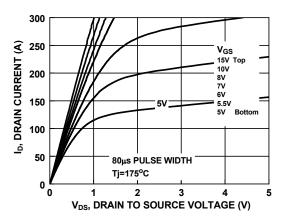


Figure 10. Saturation Characteristics

### **Typical Characteristics**

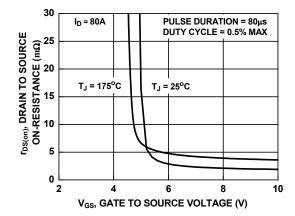


Figure 11. R<sub>DSON</sub> vs. Gate Voltage

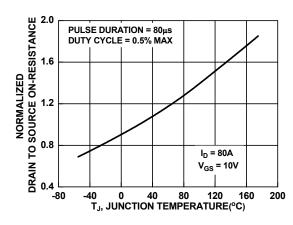


Figure 12. Normalized R<sub>DSON</sub> vs. Junction Temperature

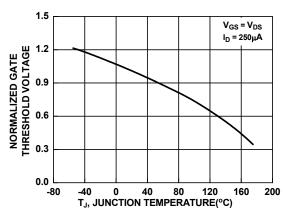


Figure 13. Normalized Gate Threshold Voltage vs. Temperature

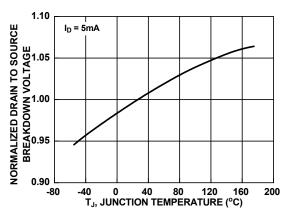


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

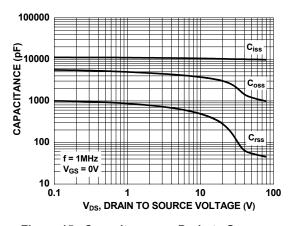


Figure 15. Capacitance vs. Drain to Source Voltage

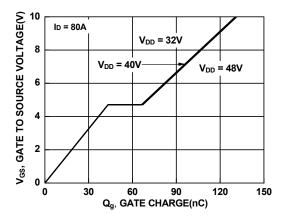
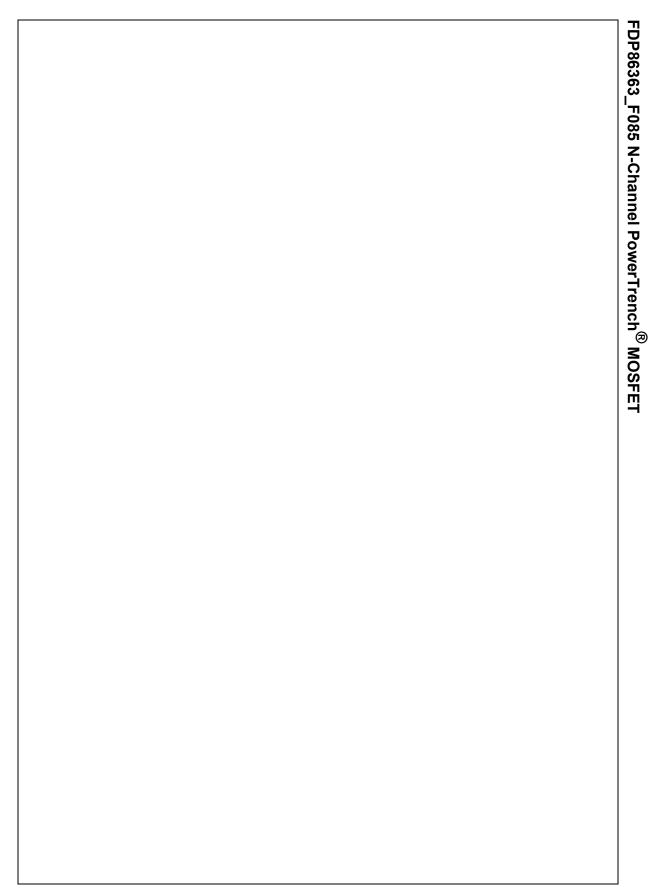


Figure 16. Gate Charge vs. Gate to Source Voltage







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